popping.

ature range.

Dual 3:1 Clickless Audio Multiplexers with Negative-Signal Handling

General Description

Applications

The MAX4908/MAX4909/MAX4930/MAX4932 dual 3:1 clickless audio multiplexers feature negative-signal

capability that allows signals as low as V_{CC} - 5.5V to

pass through without distortion. These analog multiplex-

ers have a low on-resistance (0.38 Ω), low supply current,

The MAX4908 has shunt resistors on all input terminals,

and the MAX4909 has shunt resistors on all input terminals except X0 and Y0. The MAX4930 has shunt resistors

only on the X2 and Y2 terminals, and the MAX4932 has

no shunt resistors. The shunt resistor feature reduces

click-and-pop sounds by automatically discharging the

capacitance at the input terminal when they are not connected. A break-before-make feature further reduces

The MAX4908/MAX4909/MAX4930/MAX4932 use two

digital control inputs CB1 and CB2 to switch between sig-

nals. The digital control inputs can accept up to +5.5V

The MAX4908/MAX4909/MAX4930/MAX4932 are available in 12-bump WLP and 14-pin TDFN-EP packages and operate over the -40°C to +85°C extended temper-

independent of the supply voltage.

Cell Phones

MP3 Players

PDAs and Handheld Devices

Notebook Computers

and operate from a single +1.8V to +5.5V supply.

Features

- Distortion-Free Negative Signal Throughput Down to V_{CC} - 5.5V
- Internal Shunt Resistors Reduce Click-and-Pop Sounds
- High PSRR Reduces Supply Noise
- Low On-Resistance: 0.38Ω (typ)
- Channel-to-Channel Matching: 0.1Ω (max)
- On-Resistance Flatness: 0.35Ω (max)
- Single +1.8V to +5.5V Supply Voltage
- -70dB (typ) Crosstalk (20kHz)
- -80dB (typ) Off-Isolation (20kHz)
- ♦ 0.02% (typ) Total Harmonic Distortion
- ♦ 50nA Leakage Current
- 50nA Supply Current

_Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4908ETD+T	-40°C to +85°C	14 TDFN-EP**	ABI
MAX4908EWC+T*	-40°C to +85°C	12 WLP	AAF
MAX4909ETD+T	-40°C to +85°C	14 TDFN-EP**	ABJ
MAX4909EWC+T*	-40°C to +85°C	12 WLP	AAG
MAX4930ETD+T	-40°C to +85°C	14 TDFN-EP**	ADM
MAX4930EWC+T*	-40°C to +85°C	12 WLP	ADY
MAX4932ETD+T	-40°C to +85°C	14 TDFN-EP**	ADN
MAX4932EWC+T*	-40°C to +85°C	12 WLP	AAN

+Denotes a lead-free/RoHS-compliant package.

T = Tape and reel.

*Future product—contact factory for availability. **EP = Exposed pad.

Pin Configurations



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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)

V _{CC} , CB	-0.3V to +6.0V
X, X_, Y, Y	$(V_{CC} - 6V)$ to $(V_{CC} + 0.3V)$
Continuous Current X, X_, Y, Y	±300mA
Peak Current X, X_, Y, Y_ (pulsed at	1ms,
50% Duty Cycle)	±400mA
Peak Current X, X_, Y, Y_ (pulsed at	1ms,
10% Duty Cycle)	±500mA

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
12-Bump WLP (derate 8.5mW/°C above +70°C)6	78mW
14-Pin TDFN, Single-Layer Board	
(derate 18.5mW/°C above +70°C)14	82mW
14-Pin TDFN, Multilayer Board	
(derate 24.4mW/°C above +70°C)19)51mW
Operating Temperature Range40°C to	+85°C
Junction Temperature+	·150°C
Storage Temperature Range65°C to +	·150°C
Lead Temperature (soldering, 10s)+	·300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +2.7V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.0V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIO	NS	MIN	ТҮР	MAX	UNITS
POWER SUPPLY							
Supply Voltage	Vcc			1.8		5.5	V
		$V_{CC} = +5.5V, V_{CB} = 0V \text{ or } V$	СС		0.05	2	
Supply Current	ICC	$V_{CC} = +2.7V, V_{CB} = +0.5Vc$	or +1.4V			4	μA
		$V_{CC} = +5.5V, V_{CB} = +0.5Vc$	or +1.4V			8	
ANALOG SWITCH							
Analog Signal Range (Note 2)	V _{X_} , V _{Y_} , V _X , V _Y			V _{CC} - 5.5V		V _{CC}	V
On-Resistance (Note 3)	Box	$V_{CC} = +2.7V; V_X = V_Y = V_{CC} = 5.5V; -1V, 0V, +1V,$	$T_A = +25^{\circ}C$		0.38	0.75	Ω
	R _{ON}	+2V, V_{CC} ; $I_X = I_Y = 100 \text{mA}$	$T_A = T_{MIN}$ to T_{MAX}			0.8	
On-Resistance Match Between Channels (Notes 3 and 4)	ΔR _{ON}	Between X0 and Y0, X1 and YCC = +2.7V; V_{X} or V_{Y} = 0V			0.1	Ω	
On-Resistance Flatness (Notes 3 and 5)	R _{FLAT}	$V_{CC} = +2.7V; V_X = V_Y = V_{CC} - 5.5V,$ -1V, 0, +1V, +2V, V_{CC}; I_X = I_Y = 100mA				0.35	Ω
Shunt Switch Resistance	R _{SH}			2	3.8	6	kΩ
X0, Y0 Off-Leakage Current			$T_A = +25^{\circ}C$	-50		+50	- nA
(MAX4909/MAX4930/MAX4932)			$T_A = T_{MIN}$ to T_{MAX}	-200		+200	
X1, Y1 Off-Leakage Current	IL(OFF)		$T_A = +25^{\circ}C$	-50		+50	
(MAX4930/MAX4932)			$T_A = T_{MIN}$ to T_{MAX}	-200		+200	
X2, Y2 Off-Leakage Current (MAX4932)			$T_A = +25^{\circ}C$	-50		+50	
			$T_A = T_{MIN}$ to T_{MAX}	-200		+200	
X, Y On-Leakage Current		V_{CC} = +2.7V, switch closed, V _{X0} or V _{Y0} = -2.5V or +2.5V	$T_A = +25^{\circ}C$	-100		+100	nA
	I _{L(ON)}	or unconnected, $V_X = V_Y =$ -2.5V or +2.5V or floating	$T_A = T_{MIN}$ to T_{MAX}	-300		+300	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +2.7V \text{ to } +5.5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } V_{CC} = +3.0V, T_A = +25^{\circ}C.)$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
DYNAMIC CHARACTERISTIC	S					
Turn-On Time	ton	V_{CC} = +2.7V, CB_ = low to high, R _L = 50 Ω , C _L = 5pF, Figure 2		1.0		μs
Turn-Off Time	toff	V_{CC} = +2.7V, CB_ = high to low, R _L = 50 Ω , C _L = 5pF, Figure 2		1.0		μs
Break-Before-Make Delay Time	tD	V_{CC} = +2.7V, CB_ = low to high or high to low, R _L = 50 Ω , C _L = 5pF, Figure 3	1.0	15		ns
Charge Injection	Q	$V_X = V_Y = 0V$, $R_{GEN} = 0\Omega$, $C_L = 1nF$, Figure 4		300		рС
Power-Supply Rejection Ratio	PSRR	f = 20kHz, V _X or V _Y = 1V _{RMS} , R _L = 50 Ω , C _L = 5pF		60		dB
Off-Isolation	VISO	f = 20kHz, V _X = V _Y = 1V _{RMS} , R _L = 50 Ω , Figure 5 (Note 6)		-80		dB
Crosstalk	V _{CT}	f = 20kHz, V _X or V _Y = 1V _{RMS} , R _L = 50 Ω , Figure 5		-70		dB
Total Harmonic Distortion	THD	f = 20Hz to 20kHz, V _X or V _Y = 0.5V _{P-P} , R _L = 50 Ω , DC bias = 0		0.02		%
X_, Y_Off-Capacitance	CX_(OFF) CY_(OFF)	f = 1MHz, V _X or V _Y = 0.5V _{P-P} , DC bias = 0, Figure 6		200		pF
X, Y On-Capacitance	C _{X(ON)} C _{Y(ON)}	f = 1MHz, V _X or V _Y = 0.5V _{P-P} , DC bias = 0, Figure 6		450		pF
DIGITAL INPUTS (CB_)	•	•	•			
Input Logic High	VIH		1.4			V
Input Logic Low	VIL				0.5	V
Input Leakage Current	ICB	V_{CB} = 0V or V_{CC}	-1		+1	μA

Note 1: All parameters are production tested at $T_A = +25^{\circ}C$ and guaranteed by design over the specified temperature range.

Note 2: Signals on X, Y, X_, or Y_exceeding V_{CC} are clamped by internal diodes. Limit forward-diode current to maximum current rating. **Note 3:** Guaranteed by design; not production tested.

Note 4: $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$.

Note 5: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Note 6: X Off-Isolation = $20\log_{10} [V_X / V_X]$, V_X = output, V_X = input to off switch. Y Off-Isolation = $20\log_{10} [V_Y / V_Y]$, V_Y = output, V_Y = input to off switch.



M/IXI/M

Typical Operating Characteristics (continued)

 $(V_{CC} = 3.0V, T_A = +25^{\circ}C, unless otherwise noted.)$













CROSSTALK vs. FREQUENCY





Pin Description

PI	N	NAME	FUNCTION	
TDFN-EP	WLP	NAIVIE	FUNCTION	
1	B4	V _{CC}	Positive Supply Voltage Input	
2	C4	Х	Analog Output X Common Terminal	
3,10	_	N.C.	No Connection. Not internally connected.	
4	C3	X2	Analog Input X2	
5	C2	X1	Analog Input X1	
6	B2	CB1	Digital Control Input 1	
7	C1	XO	Analog Input X0	
8	B1	GND	Ground	
9	A1	YO	Analog Input Y0	
11	A2	Y1	Analog Input Y1	
12	A3	Y2	Analog Input Y2	
13	B3	CB2	Digital Control Input 2	
14	A4	Y	Analog Output Y Common Terminal	
		EP	Exposed Pad. Connect to ground or leave unconnected.	

Detailed Description

The MAX4908/MAX4909/MAX4930/MAX4932 dual 3:1 clickless audio multiplexers are low 0.38 Ω (typ) on-resistance, low 150nA (typ) supply current, high power-supply rejection ratio (PSRR) devices that operate from a +1.8V to +5.5V single supply. These devices feature a negative signal capability that allows signals below GND to pass through without distortion and break-beforemake switching.

The MAX4908/MAX4909/MAX4930/MAX4932 use two digital control bits CB1 and CB2 to switch between signals (see Table 1). The MAX4908 has shunt resistors on all the unselected terminals to suppress click-and-pop sounds that may occur from switching to a pre-charged terminal. The MAX4909 does not have click-and-pop suppression resistors on X0 and Y0 terminals for applications that do not require predischarge switching. The MAX4930 only has shunt resistors on X2 and Y2 terminals. The MAX4932 has no shunt resistors on all terminals.

CB1	CB2	COMMON X	COMMON Y
0	0	High Impedance	High Impedance
0	1	Connected to X0	Connected to Y0
1	0	Connected to X1	Connected to Y1
1	1	Connected to X2	Connected to Y2

Table 1. Truth Table

Applications Information

Digital Control Inputs

The MAX4908/MAX4909/MAX4930/MAX4932 logic inputs accept up to +5.5V regardless of supply voltage. For example, with a +3.3V supply, CB_ can be driven low to GND and high to +5.5V, allowing for mixing of logic levels in a system. Driving CB_ rail-to-rail minimizes power consumption. For a +3.3V supply voltage, the logic thresholds are +0.5V (low) and +1.4V (high).

Analog Signal Levels

The MAX4908/MAX4909/MAX4930/MAX4932 have a low on-resistance of 0.38 Ω (typ) and the on-resistance flatness is guaranteed over temperature and will show minimal variation over the entire voltage supply range (see the *Typical Operating Characteristics*). The on-resistance flatness and low-leakage features make it ideal for bidirectional operation. The switches are bidirectional, so X_, Y_, and common terminals X and Y pins can be either inputs or outputs.

These devices pass signals as low as V_{CC} - 5.5V, including signals below ground with minimal distortion.



_Functional Diagram

Click-Pop Suppression

The MAX4908 has a $3.8k\Omega$ (typ) shunt resistor on all of its input terminals to automatically discharge any capacitance when they are not connected to common terminal X and Y. The MAX4909 has shunt resistors on all terminals except X0 and Y0. The MAX4930 only has shunt resistors on X2 and Y2. The shunt resistors reduce audible click-and-pop sounds that occur when switching between audio sources.

Audible clicks and pops are caused when a step DC voltage is switched into the speaker. The DC step transients can be reduced by automatically discharging the

side that is not connected to the common terminal, thus reducing any residual DC voltage and clicks and pops.

Break-Before-Make Switching

The MAX4908/MAX4909/MAX4930/MAX4932 feature break-before-make switching, which is configured to break (open) the first set of contacts before engaging (closing) the new contacts. This prevents the momentary connection of the old and new signal paths to the output, further reducing click-and-pop sounds.



MAX4908/MAX4909/MAX4930/MAX4932



Power-Supply Sequencing and Overvoltage Protection Caution: Do not exceed the Absolute Maximum Ratings since stresses beyond the listed ratings

may cause permanent damage to the device. Proper power-supply sequencing is recommended for all CMOS devices. Improper supply sequencing can force the switch into latchup, causing it to draw excessive supply current. The only way out of latchup is to recycle the power and reapply properly. Connect all ground pins first, apply power to V_{CC}, and finally apply signals to X_, Y_, and common terminals. Follow the reverse order upon power-down.



Figure 1. Typical Application Circuit



Figure 2. Switching Time



Figure 3. Break-Before-Make Interval







_Test Circuits/Timing Diagrams (continued)



Figure 5. On-Loss, Off-Isolation, and Crosstalk



Figure 6. Channel Off/On-Capacitance

_Chip Information

PROCESS: BICMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
14 TDFN	T1433-2	<u>21-0137</u>
12 WLP	W121B2-1	<u>21-0009</u>

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
1	7/07	Adding of the MAX4930/MAX4932	1-13
2	6/08	Changing UCSP to WLP packaging	1,2,6,8,11

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